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FormFactor Expands Customer Service and Repair Center in Singapore

New Clean Room Space and Capabilities Added to Support MicroProbe Products

SINGAPORE -- (Marketwired) -- 09/10/13 -- FormFactor Inc. (NASDAQ: FORM) today announced it has completed the expansion of the company's Customer Service and Repair center in Singapore. This expansion includes more than doubling to 105 square meters the Singapore clean room space for the repair, rebuild, test, and cleaning of FormFactor products, including those from the MicroProbe Product Group. This expansion further strengthens FormFactor's capability to meet local customers' critical requirements for reduced wafer probe card repair turnaround times and product service.

"Singapore plays an important role in FormFactor's global strategy and we are continuing to invest in our local Singapore capabilities" said FormFactor CEO Tom St. Dennis. "In addition to the service and repair expansion in Singapore, we are also expanding our design engineering team & resources that support customers worldwide."

About FormFactor:

FormFactor Inc. (NASDAQ: FORM) is a leader in advanced wafer test solutions. The company's advanced wafer probe cards enable semiconductor manufacturers to lower their overall production costs, improve yields, and bring next-generation devices to market. FormFactor's acquisition of MicroProbe creates the leading wafer test solution provider for both memory and non-memory semiconductor manufacturers. FormFactor is headquartered in Livermore, California with operations in Europe, Asia and North America. For more information, visit the company's website at www.formfactor.com.

FormFactor, MicroProbe and the FormFactor and MicroProbe logos are registered or unregistered trademarks of FormFactor, Inc. All other product, trademark, company or service names mentioned herein are the property of their respective owners.

Forward-looking Statements:

Statements in this press release that are not strictly historical in nature are forward-looking statements within the meaning of the federal securities laws, including statements regarding anticipated results, market conditions, expectations and operating plans. These forward-looking statements are based on current information and expectations that are inherently subject to change and involve a number of risks and uncertainties. Actual events or results might differ materially from those in any forward-looking statement due to various factors, including, but not limited to: risks that the company will be able to meet customers' critical requirements for reduced wafer probe card repair turnaround times and expert product service repair, service and support; and risks that the company's Singapore design engineering team & resources will be able to support customers worldwide. Additional information concerning factors that could cause actual events or results to differ materially from those in any forward-looking statement is contained in the company's Form 10-K for the fiscal year ended December 29, 2012, as filed with the SEC, and subsequent SEC filings, including the company's Quarterly Reports on Forms 10-Q. Copies of the company's SEC filings are available at <http://investors.formfactor.com/edgar.cfm>. The company assumes no obligation to update the information in this press release, to revise any forward-looking statements or to update the reasons actual results could differ materially from those anticipated in forward-looking statements.

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Trade Contact

Nigel Ooi
Country Manager
+65 65001482
[Email Contact](#)

Investor Contact

Stan Finkelstein
Investor Relations
+1 (925) 290-4321
[Email Contact](#)

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